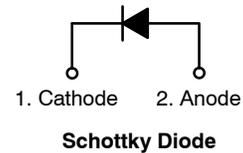


# Silicon Carbide (SiC) Schottky Diode – EliteSiC, 8 A, 650 V, D1, TO-220F-2L

## FFSPF0865A



### Description

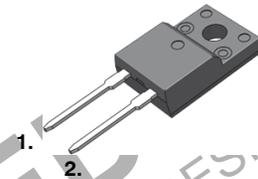
Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

### Features

- Max Junction Temperature 175°C
- Avalanche Rated 49 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery
- This Device is Pb-Free, Halogen Free/BFR Free and RoHS Compliant

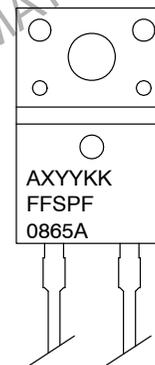
### Applications

- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits



TO-220 FP / TO-220F-2FS  
CASE 221AS

### MARKING DIAGRAM



A	= Assembly Plant Code
XY	= Data Code (Year & Week)
YY	= Lot Traceability Code
FFSPF0865A	= Specific Device Code

### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

# FFSPF0865A

## ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise noted)

Symbol	Parameter	FFSPF0865A	Unit	
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	650	V	
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 1)	49	mJ	
I <sub>F</sub>	Continuous Rectified Forward Current @ T <sub>C</sub> < 124 °C	8	A	
	Continuous Rectified Forward Current @ T <sub>C</sub> < 135 °C	6.8		
I <sub>F, Max</sub>	Non-Repetitive Peak Forward Surge Current	T <sub>C</sub> = 25°C, 10 μs	670	A
		T <sub>C</sub> = 150°C, 10 μs	640	A
I <sub>F, SM</sub>	Non-Repetitive Forward Surge Current	Half-Sine Pulse, t <sub>p</sub> = 8.3 ms	49	A
I <sub>F, RM</sub>	Repetitive Forward Surge Current	Half-Sine Pulse, t <sub>p</sub> = 8.3 ms	25	A
P <sub>tot</sub>	Power Dissipation	T <sub>C</sub> = 25 °C	39	W
		T <sub>C</sub> = 150°C	6.4	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to + 175	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
R <sub>θJC</sub>	Thermal Resistance, Junction to Case, Max.	4.0	°C/W

## ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 8 A, T <sub>C</sub> = 25°C	-	1.50	1.75	V
		I <sub>F</sub> = 8 A, T <sub>C</sub> = 125°C	-	1.6	2.0	
		I <sub>F</sub> = 8 A, T <sub>C</sub> = 175°C	-	1.72	2.4	
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 650 V, T <sub>C</sub> = 25°C	-	-	200	μA
		V <sub>R</sub> = 650 V, T <sub>C</sub> = 125°C	-	-	400	
		V <sub>R</sub> = 650 V, T <sub>C</sub> = 175°C	-	-	600	
Q <sub>C</sub>	Total Capacitive Charge	V = 400 V	-	27	-	nC
C	Total Capacitance	V <sub>R</sub> = 1 V, f = 100 kHz	-	463	-	pF
		V <sub>R</sub> = 200 V, f = 100 kHz	-	48	-	
		V <sub>R</sub> = 400 V, f = 100 kHz	-	38	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. E<sub>AS</sub> of 49 mJ is based on starting T<sub>J</sub> = 25°C, L = 0.5 mH, I<sub>AS</sub> = 14 A, V = 50 V.

## ORDERING INFORMATION

Device	Marking	Package	Packing Method	Quantity
FFSPF0865A	FFSPF0865A	TO-220 FP / TO-220F-2FS	Tube	50 units

# FFSPF0865A

## TYPICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

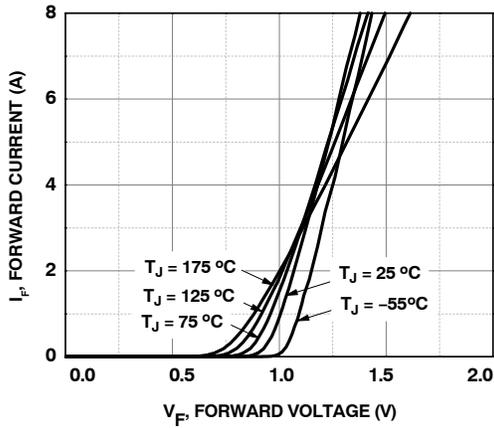


Figure 1. Forward Characteristics

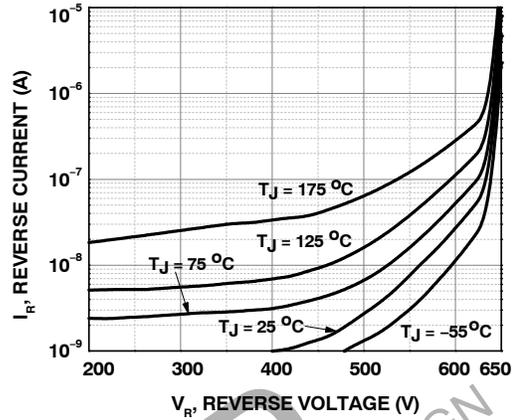


Figure 2. Reverse Characteristics

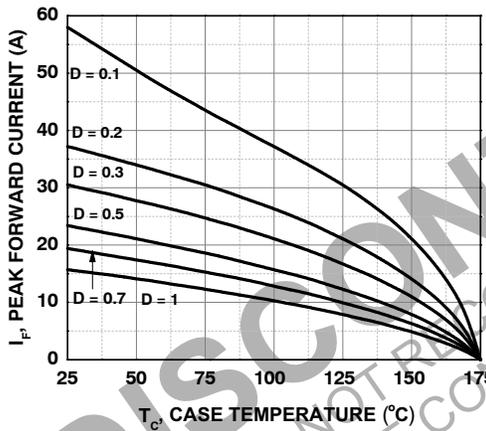


Figure 3. Current Derating

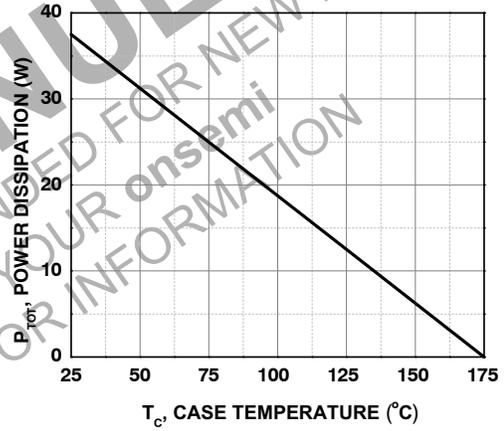


Figure 4. Power Derating

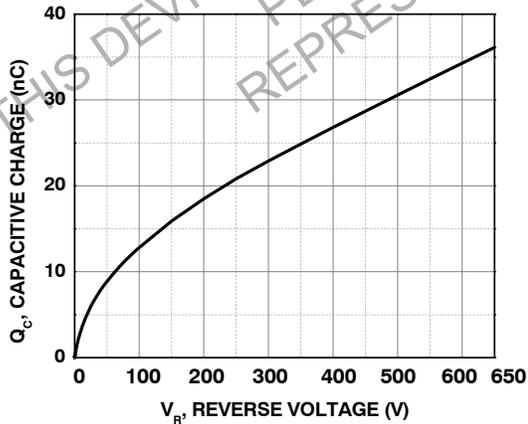


Figure 5. Capacitive Charge vs. Reverse Voltage

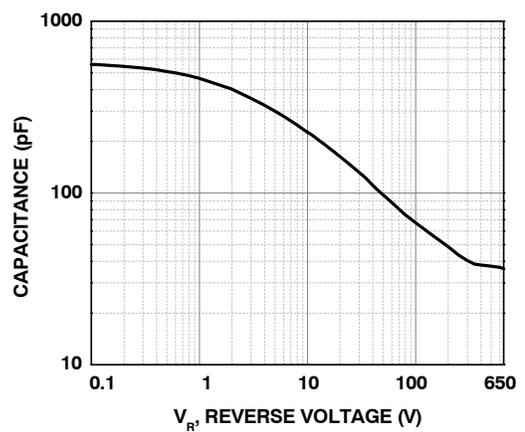


Figure 6. Capacitance vs. Reverse Voltage

TYPICAL CHARACTERISTICS  
( $T_J = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)

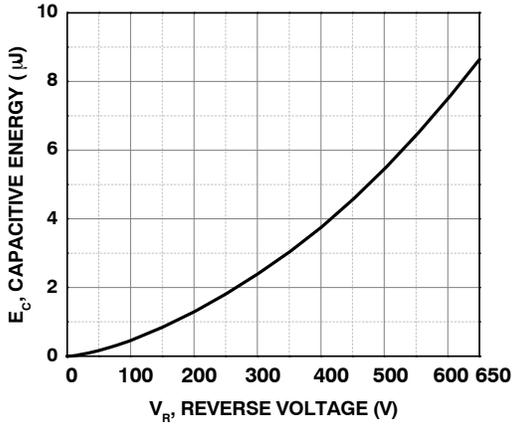


Figure 7. Capacitance Stored Energy

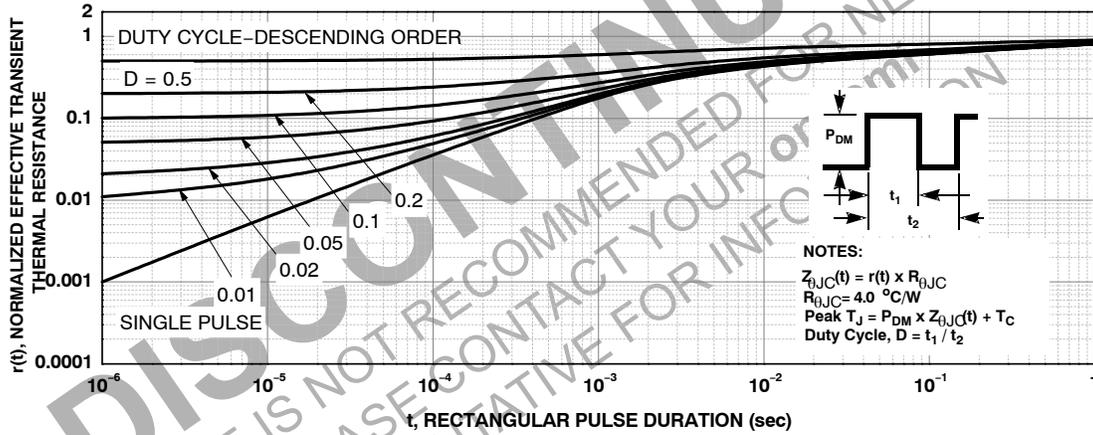


Figure 8. Junction-to-Case Transient Thermal Response Curve

TEST CIRCUIT AND WAVEFORMS

L = 0.5mH

R < 0.1Ω

V<sub>DD</sub> = 50V

EAVL = 1/2LI<sup>2</sup> [V<sub>R(AVL)</sub> / (V<sub>R(AVL)</sub> - V<sub>DD</sub>)]

Q1 = IGBT (BV<sub>CEs</sub> > DUT V<sub>R(AVL)</sub>)

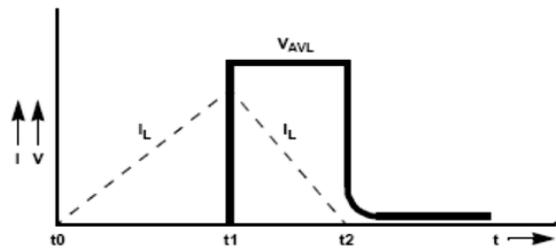
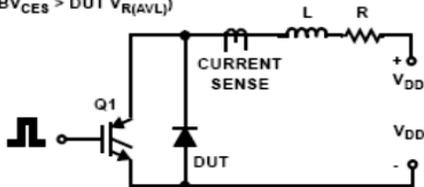


Figure 9. Unclamped Inductive Switching Test Circuit & Waveform

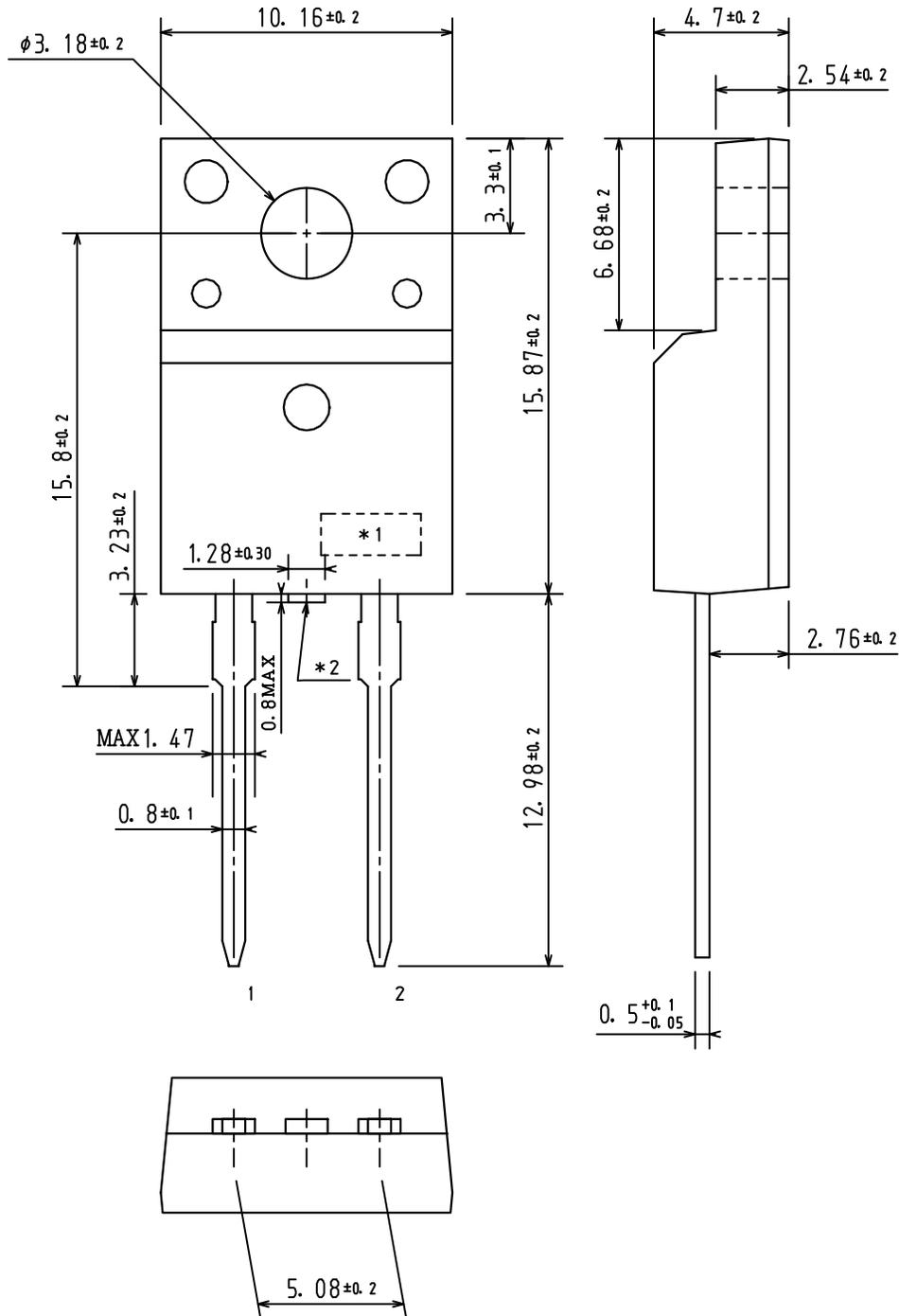
**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

ON Semiconductor®



**TO-220 Fullpack, 2-Lead / TO-220F-2FS**  
**CASE 221AS**  
**ISSUE O**

DATE 29 FEB 2012



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